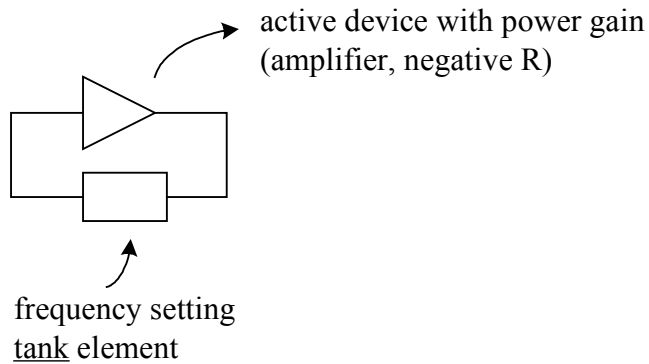


## **Oscillators and Synthesizers**

### **Oscillators**



**Why do we need oscillators** → to provide a stable frequency output

- \* useful for timekeepers
- \* useful for communications → mixing with local oscillator (LO)

### **Important attributes of oscillators**

- \* long term stability
  - temp. coefficient of oscillation frequency
  - aging and drift

### **Types of active devices used for oscillators**

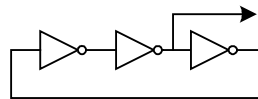
- \* 3-terminal : MOSFET, BJT
- \* 2-terminal : negative resistance diodes  
(tunnel diode, Gunn, IMPATT, ...)

### Types of tank element

- \* Quarter-wave Resonators  
Distributed elements with high  $\frac{Volume}{Surface} = Q$
- \* Lumped LC tank
- \* Xtal
- \* SAW (surface acoustic wave devices)

### Classification of oscillators

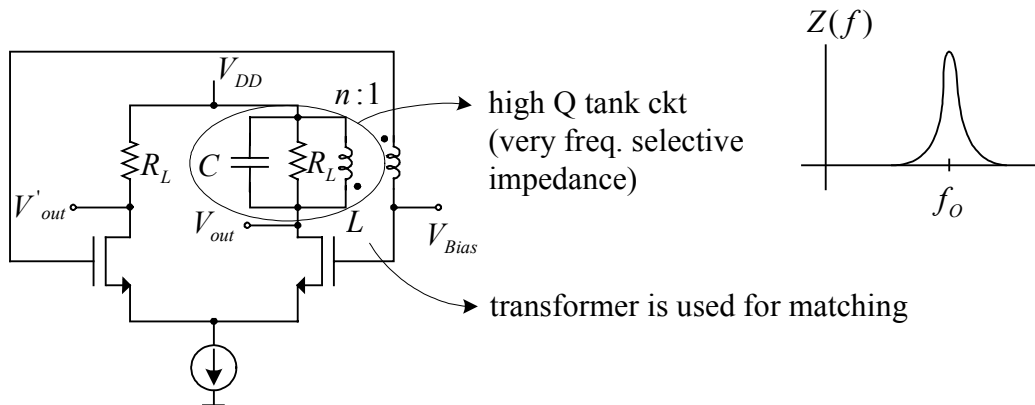
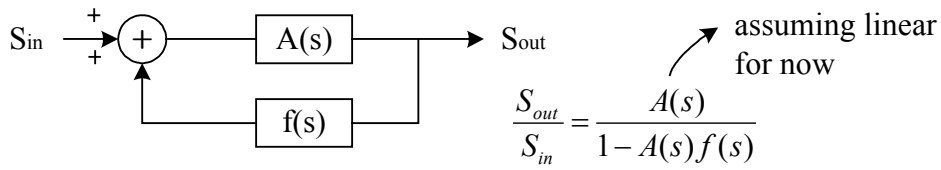
- \* near sinusoidal
  - low phase noise  
(e.g. high Q LC or Xtal Oscillators)
- \* Relaxation Oscillators
  - poor stability, but can have  
a very large tuning range  
(application → VCO)
  - (e.g. multivibrator, Ring Oscillator)



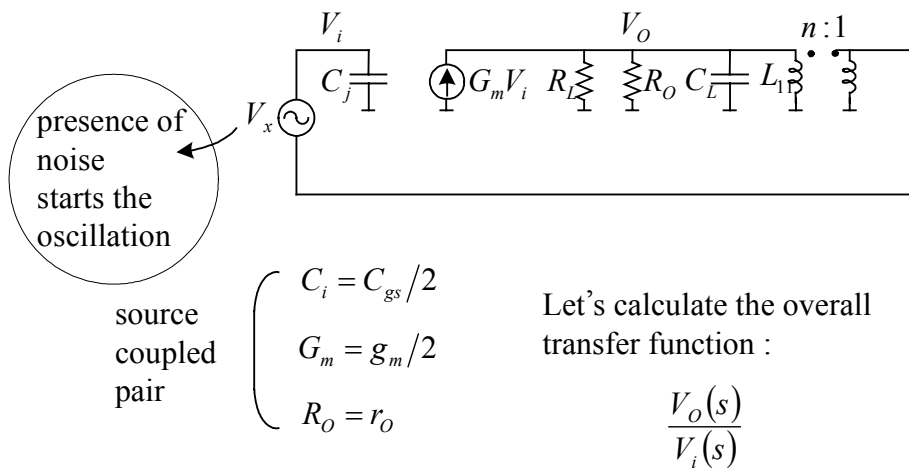
### Approaches to Oscillator Design

- \* negative R → 2-terminal active element oscillator
  - ↙
  - used at very high microwave frequencies  
> 50 GHz
- \* feedback → 3-terminal active device

We will look at the feedback approach when dealing with MOS oscillators



### AC equivalent



\* Since it is a feedback system

1) find open loop gain with feedback loading ( $A_l$ )

$$A_l = \frac{V_o}{V_i} = G_m Z_T$$

tank ckt impedance

$$Z_T = \frac{1}{R} \frac{\frac{1}{R}s}{1 + \frac{L}{R}s + s^2 LC} \quad \text{where} \quad \begin{aligned} L &= L_{11} \\ C &= C_L + \frac{C_i}{n^2} \\ R &= R_o \parallel R_L \end{aligned}$$

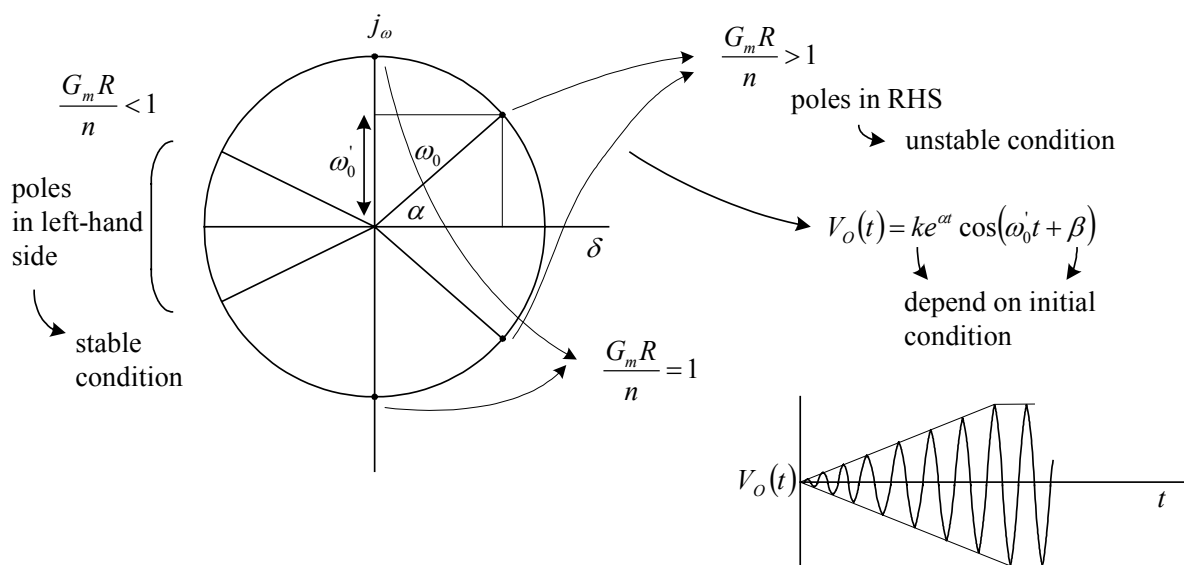
2) find feedback factor  $f(s) = \frac{1}{n}$

$$\frac{V_o(s)}{V_x(s)} = \frac{G_m L \cdot s}{1 + \frac{L}{R} \left( 1 - \frac{G_m R}{n} \right) s + s^2 LC}$$

→ response of osc. Ckt  
to an input noise  
signal  $V(x)$

$$\frac{V_o(s)}{V_x(s)} = \frac{N(s)}{D(s)} = \frac{N(s)}{(s - P_1)(s - P_2)}$$

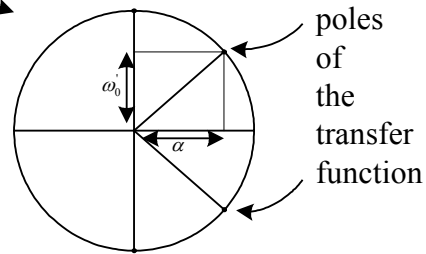
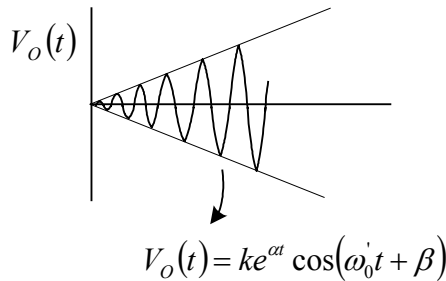
poles of the transfer function



### Oscillator response (Transfer function)

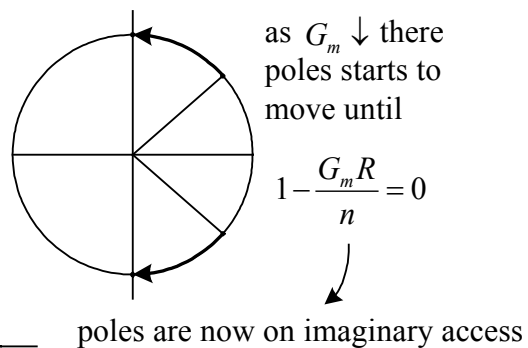
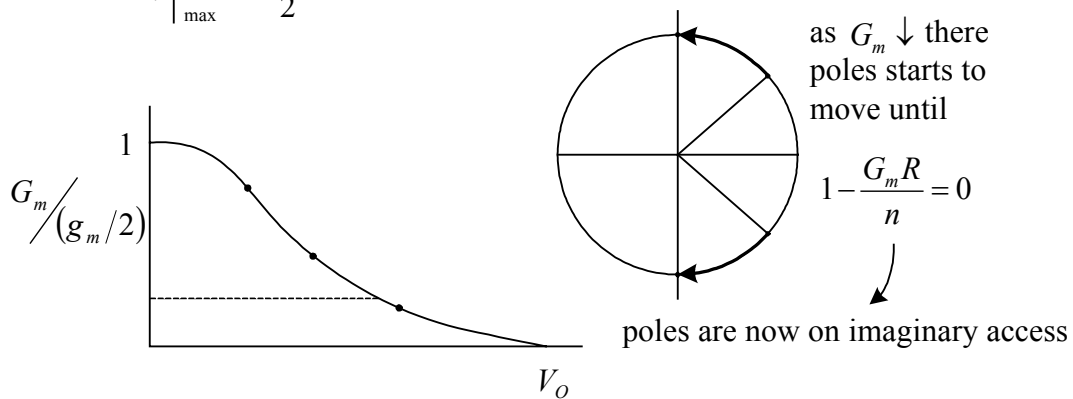
$$\frac{V_o}{V_x} = \frac{G_m L \cdot s}{1 + \frac{L}{R} \left( 1 - \frac{G_m R}{n} \right) s + s^2 LC}$$

for small signal  $G_m = \frac{g_m}{2}$

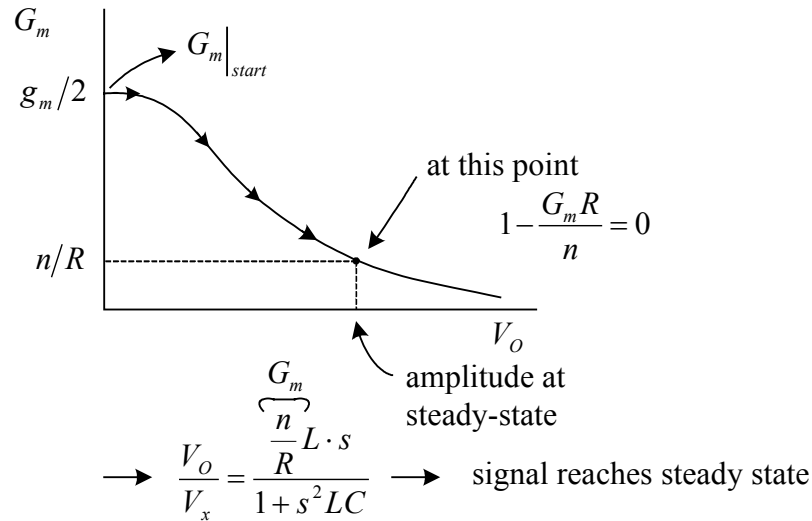


Therefore in the beginning the signal grows exponentially  
until  $\longrightarrow V_o(t)$  is no longer a small-signal for the oscillator  
 $\longrightarrow$  in large-signal operation  $G_m$  starts to decrease

$$G_m \Big|_{\max} = \frac{g_m}{2} = \text{small-signal transconductance}$$

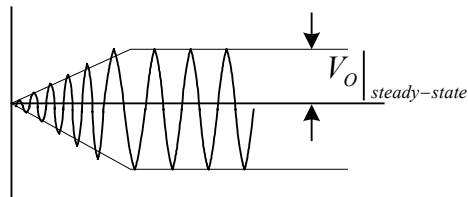


Once poles are on imaginary axis the signal amplitude does not grow any more



current may be non-sinusoidal but very selective  
tuned circuit tunes out the fundamental component at  $\omega_0$

$$\omega_0 = \frac{1}{\sqrt{LC}}$$



typically  $\frac{G_m|_{start}}{G_m|_{steady-state}} > 3$

to make sure

1. oscillation starts
2. enough amplitude for your near-sinusoidal

$$\frac{g_m/2}{n/R} > 3 \rightarrow g_m > \frac{6n}{R}$$

a function of device size (W/L) and also gate overdrive ( $V_{gs} - V_T$ )

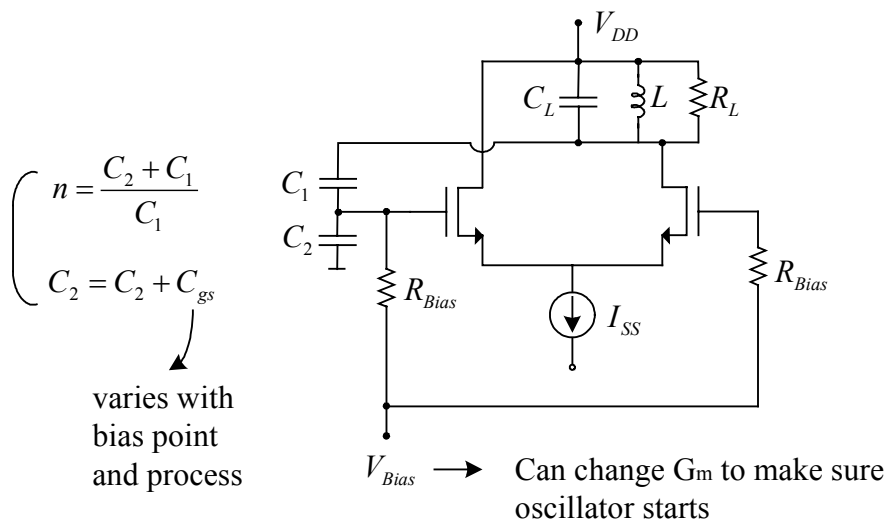
Problem with transformers:

- \* cannot be integrated
- \* low frequency
- \* low Q

solution → use capacitive transformer

$$\begin{array}{c} \text{---} \\ | \\ C_1 \\ | \\ \text{---} \\ | \\ C_2 \\ | \\ \text{---} \end{array} \parallel R_L \equiv \frac{C_1 C_2}{C_1 + C_2} \parallel \frac{C_1 + C_2}{C_1} R_L$$

Source-coupled pair oscillator (at higher-freq.)

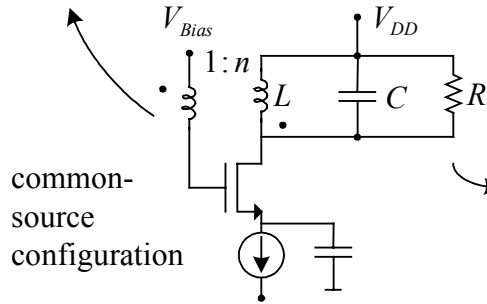


so we often design

$C_{gs} < C_2$  such that oscillator  
performance becomes independent  
of transistor parameters

## Single active device oscillators

180° phase shift



common-source configuration

(pierce configuration)

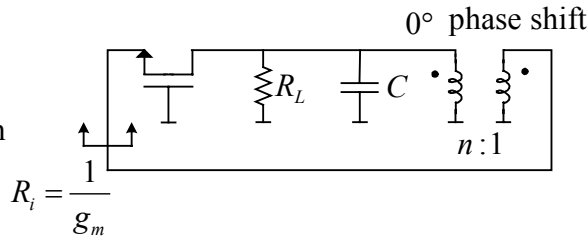
small-signal loop gain  $A_i = \frac{g_m R_L}{n}$

$R_L = R \parallel \text{loading}$

large-signal loop gain  $= \frac{G_m R_L}{n} = 1$

$$\frac{G_{mL}}{g_m} = \frac{1}{A_i} : \text{describing function for single transistor oscillator}$$

common-gate configuration



0° phase shift

small-signal loop gain :

initial loop gain  $\leftarrow A_i = \frac{g_m R_L}{n} \left( 1 + \frac{g_m R}{n^2} \right)^{-1}$  (1)  
typically  $> 3$

steady-state large-signal loop gain :

$$\frac{G_m R_L}{n} \left( 1 + \frac{G_m R}{n^2} \right)^{-1} = 1$$

$$\frac{G_m R_L}{n} = 1 + \frac{G_m R}{n^2}$$

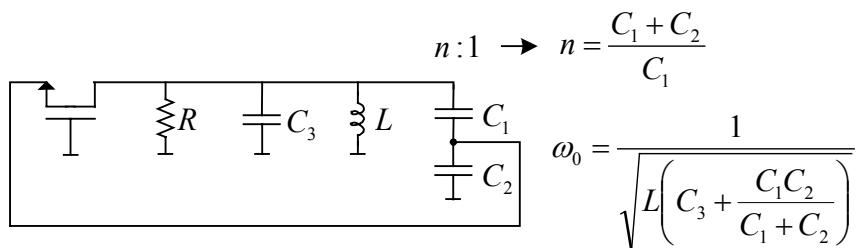
$$1 = \frac{n}{G_m R_L} + \frac{1}{n} \rightarrow \left( 1 - \frac{1}{n} \right) \frac{G_m R_L}{n} = 1 \quad (2)$$



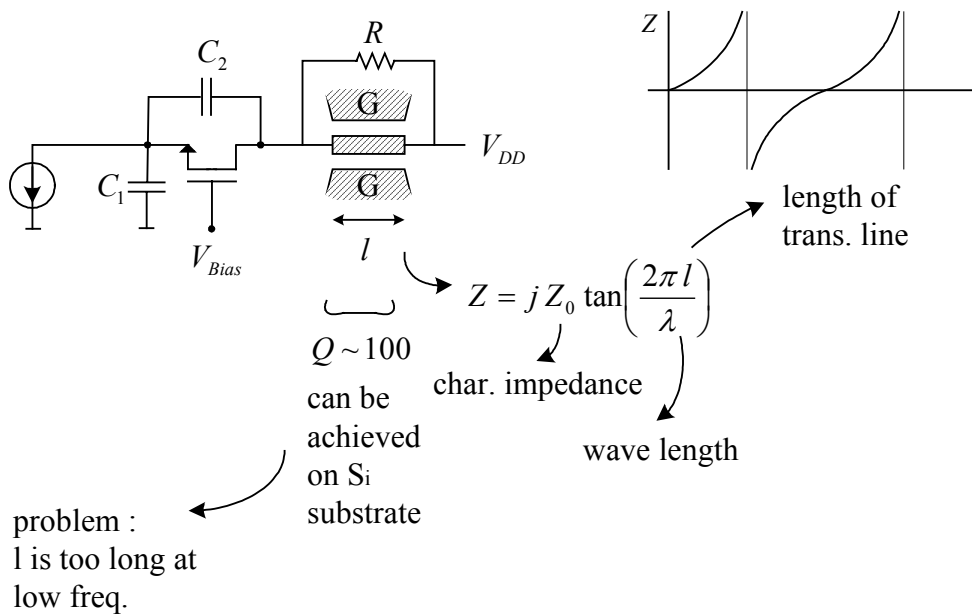
$$\left. \begin{aligned} (1) & \rightarrow \frac{g_m R_L}{n} = \frac{A_i}{1 - A_i/n} \\ (2) & \rightarrow \frac{G_m R_L}{n} = \frac{1}{1 - 1/n} \end{aligned} \right\} \text{divide} \rightarrow \frac{G_m}{g_m} = \frac{1}{A_i} \left( \frac{1 - A_i/n}{1 - 1/n} \right)$$

### Another widely used oscillator :

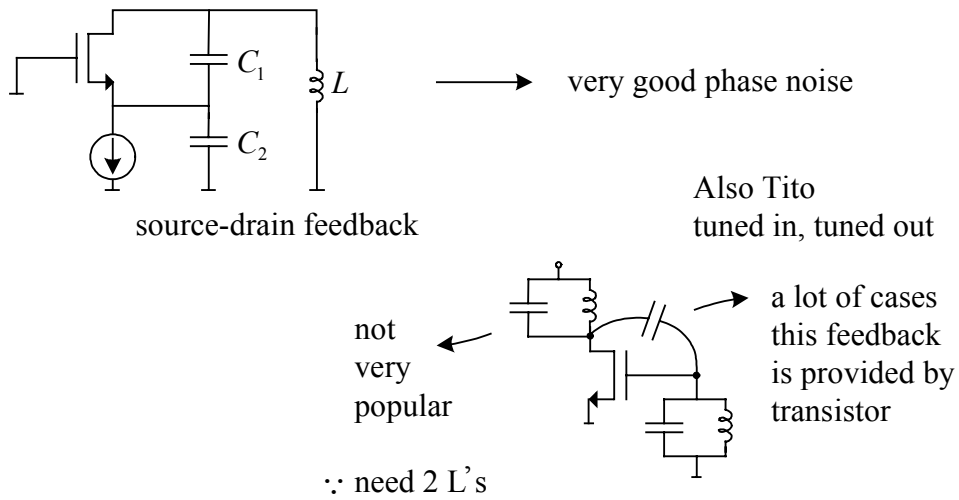
#### Colpitts oscillator



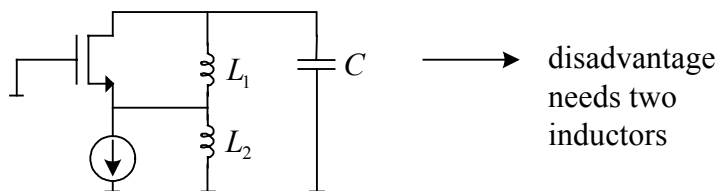
you can use transmission line instead of inductor  
(for higher Q and higher freq.)



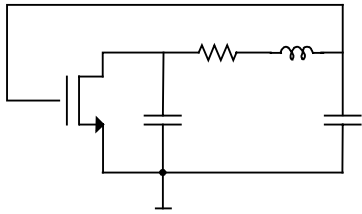
### Colpitts oscillator



### Hartley Oscillator



### Pierce Oscillator

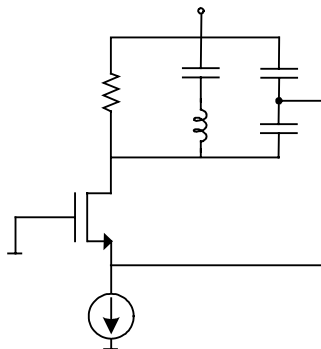


→ often used  
for Xtal Oscillator

### Clapp Oscillator

basically colpitts  
with additional  
capacitor tap

→ replace L with series LC



→ voltage across L can be higher than device breakdown voltage

→ better spectral purity

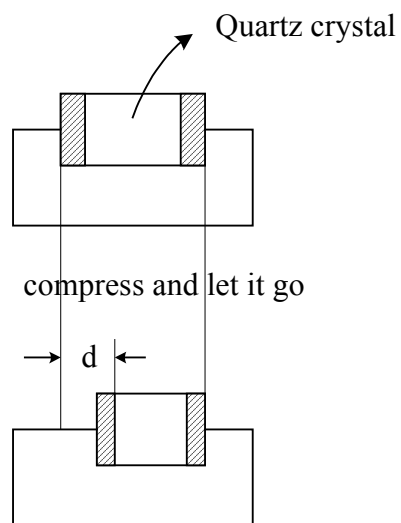
## Quartz Crystals

Quartz : single crystal  $SiO_2$

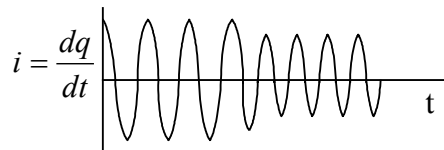
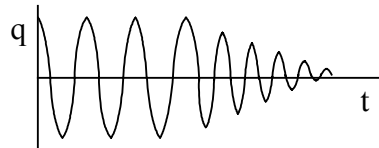
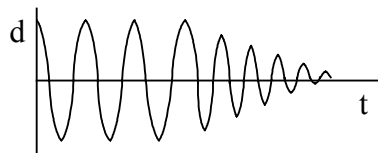
It is a piezoelectric material :

displacement  $\underline{d}$  generates a charge  $\underline{q} \rightarrow q \propto d$

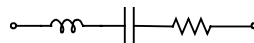
## Experiment



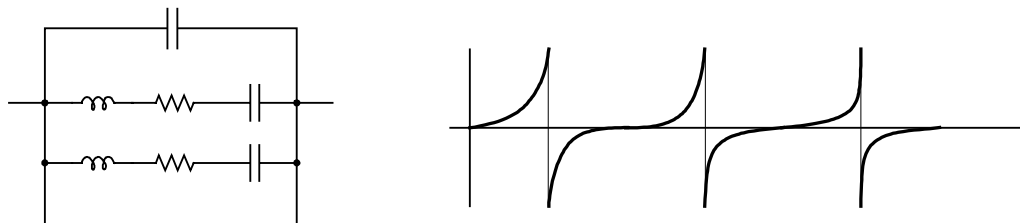
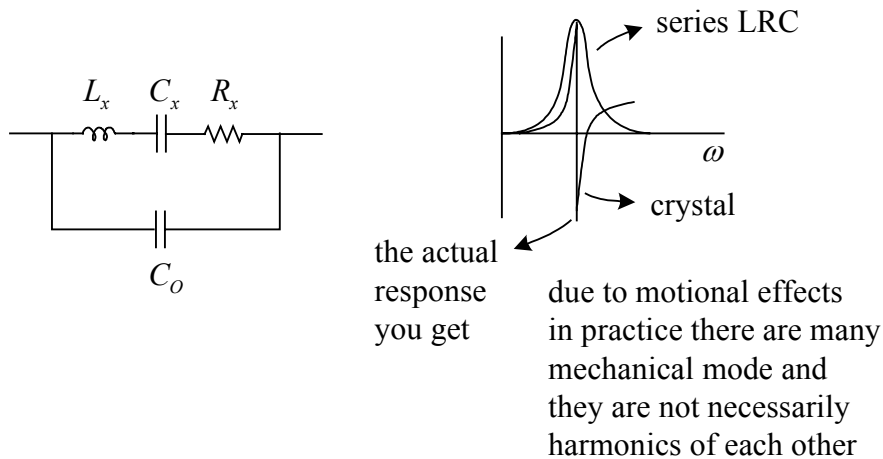
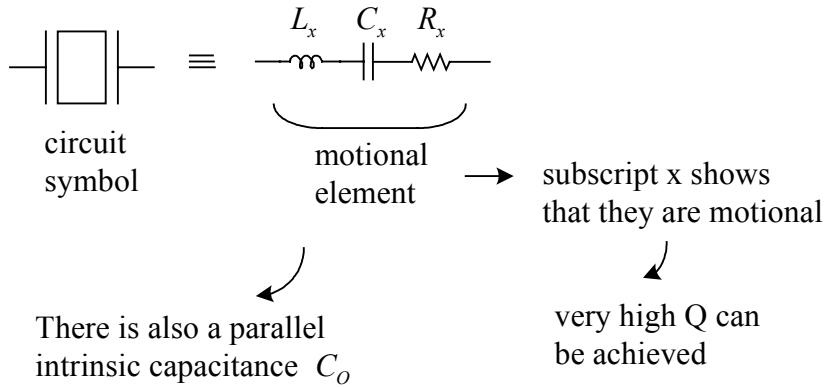
Quartz growth  
takes several months  
Quartz cannot be  
integrated with Si  
Process



you can get the  
same response  
from RLC



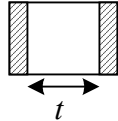
### Equivalent ckt for a quartz crystal



### Xtal resonance frequency

Set by geometry and the speed of acoustic waves in the material

$$f_0 = \frac{1}{\eta}, \quad \tau = \frac{2t}{v} \rightarrow \begin{array}{l} \text{thickness of quartz blank} \\ \text{acoustic wave propagation} \\ \text{velocity} \sim 3 \times 10^3 \text{ m/sec} \end{array}$$



for  $t = 1 \text{ mm}$

$$\eta = 0.67 \mu\text{sec}$$

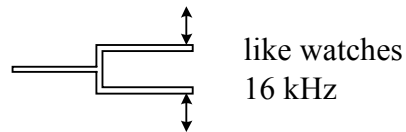
$$\rightarrow f_0 = 1.5 \text{ MHz}$$

Practical limitation  $\sim 200 \text{ MHz}$

since it gets too thin and fragile

\* for  $f_0 > 50 \text{ MHz}$  use overtones

\* for very low freq. use tuning forks



### How accurately must they be cut?

Example : watch application

1 sec /month is acceptable

$$\therefore \frac{1 \text{ sec}}{60 \times 60 \times 24 \times 31 \text{ sec}} = 0.4 \text{ ppm} \quad \text{accuracy}$$

$f_0 = 1.5 \text{ MHz}$  need 0.6 ppm accuracy in thickness

$$\text{if } t = 1 \text{ mm} \rightarrow \Delta t = 0.6 \text{ ppm} = 6 \text{ \AA} \sim 2 \text{ atoms}$$

sequence of xtal fabrication process :

- ① Polish them down to the ~ right thickness
- ② Chemical etch
- ③ Deposit gold to get a fixed mass

↙  
This affects the freq.

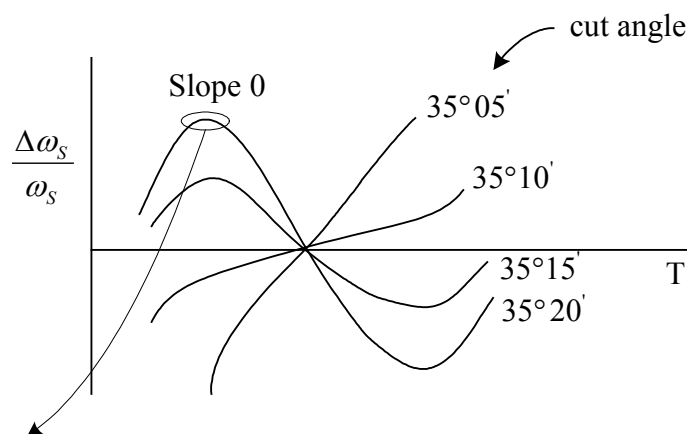
Temperature coefficient of  $f_0$

$$f_0 = \frac{1}{\eta} = \frac{v}{2t} \quad \leftarrow \text{both have TCF} \sim 14 \text{ ppm}/^\circ\text{C}$$

but not complete cancellation  
in the end we get  
certain cut angle

$$\text{TCF}/f_0 \sim 0.5 \text{ ppm}/^\circ\text{C} \text{ average}$$

for AT cut crystal

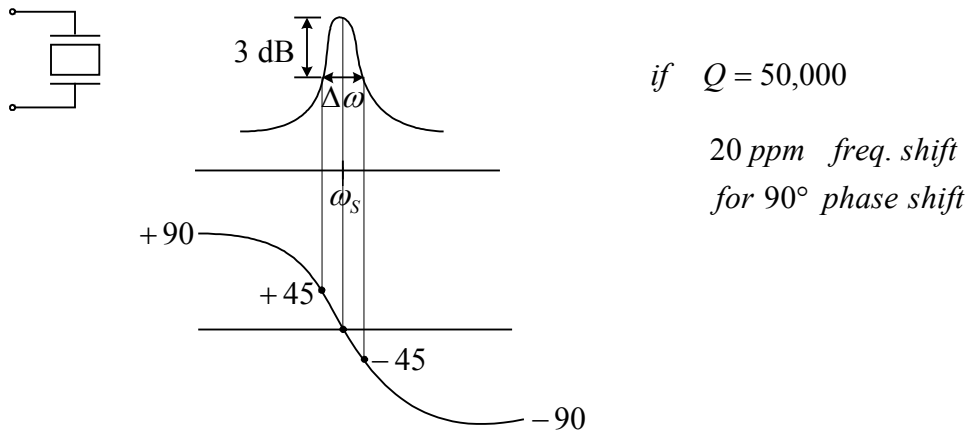


oven controlled OSC : used for very accurate synthesizer

↙  
you wait 15 min to warm up

what controls the overall temp coeff. of a high-Q oscillator

$$\Delta\omega = \frac{\omega_s}{Q} \longrightarrow \text{give } 90^\circ \text{ phase shift}$$



Suppose active device in osc. has  $\Delta\phi = 25^\circ$  phase shift  
over  $100^\circ\text{C}$   $\Delta T$

$\therefore$  Oscillator loop phase-shift has  $\Delta\phi = 0.25^\circ/^\circ\text{C}$

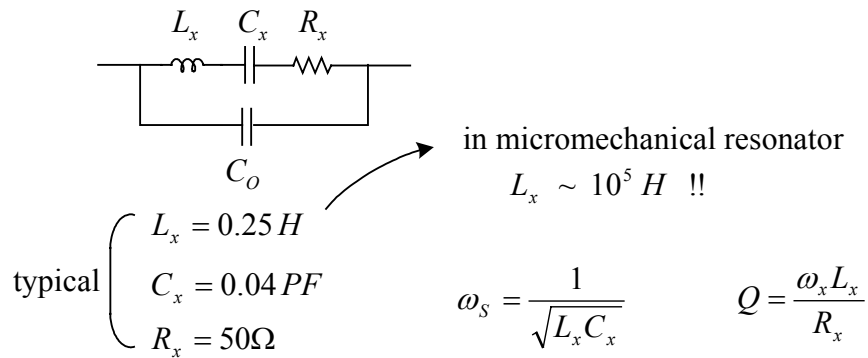
This  $\Delta\phi$  in loop phase-shift must be  
compensated by xtal phase shift

$$\Delta\omega = \frac{20 \text{ ppm}}{90^\circ} \times 0.25^\circ/^\circ\text{C} = 0.06 \text{ ppm}/^\circ\text{C}$$

shift in freq. due to variation  
in the phase of the active device



Conclusion : Oscillator temperature stability is set by crystal, not the active device

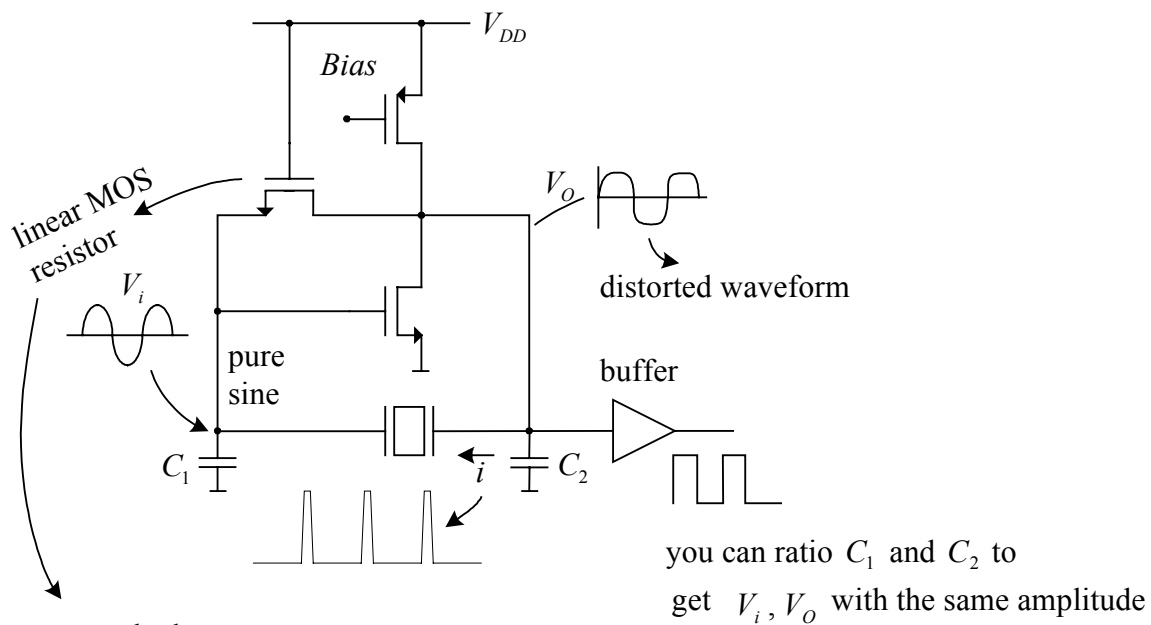


### Crystal Oscillator

Pierce, Colpitts, Clapp ...

→ best configuration for xtal osc.

### Pierce xtal oscillator



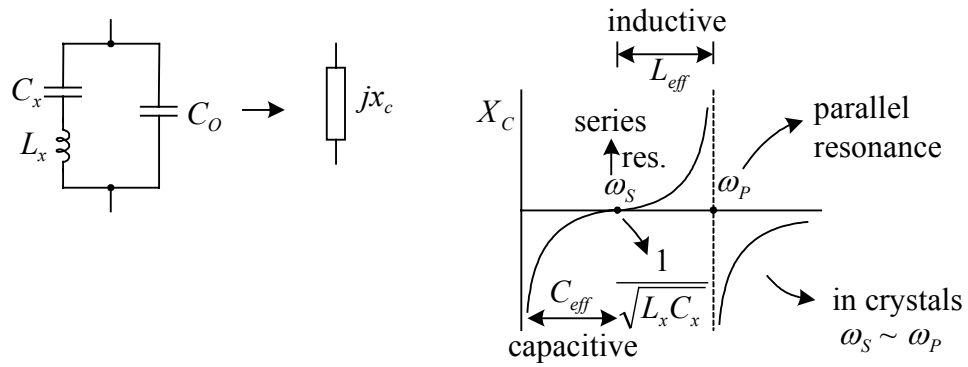
want to be large  
typical values

you get  $R \sim 200 k\Omega$   
limited by geometry  
of the transistor

→ can get higher R if operates  
in weak inversion (subthreshold)

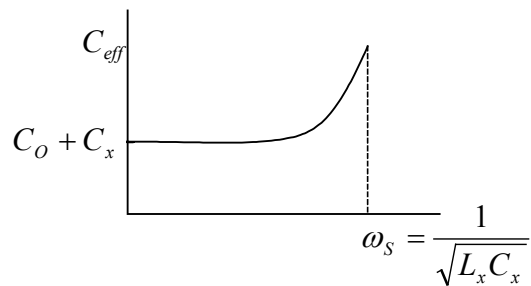
you can get substitute crystal with  $L_{eff}$

### Closer look at crystal



$$\begin{aligned}
 \text{below } \omega_s \longrightarrow jx_c &= \frac{1}{j\omega C_{eff}} \\
 &= \frac{1}{j\omega C_o} \parallel \left( \frac{1}{j\omega C_x} + j\omega L_x \right) \\
 &= \frac{1}{j\omega C_o} \parallel \left( \frac{1}{j\omega C_x} (1 - \omega^2 L_x C_x) \right)
 \end{aligned}$$

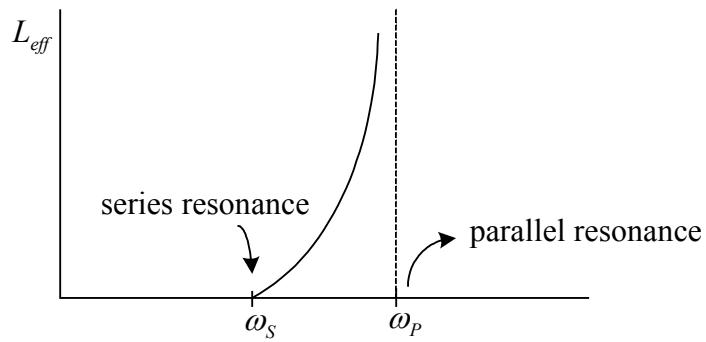
$$C_{eff} = C_o + \frac{C_x}{1 - \omega^2 L_x C_x}$$



between  $\omega_S$  and  $\omega_P$

$$jx_c = j\omega L_{eff}$$

$$j\omega L_{eff} = \frac{1}{j\omega C_o} \parallel j\omega L_x \left( 1 - \frac{1}{\omega^2 L_x C_x} \right)$$



in crystals  $\omega_S \sim \omega_P$

For pierce oscillator the oscillator freq.  $\sim \omega_P$

in order to get  $90^\circ$  phase-shift  
across the crystal

@ parallel resonance

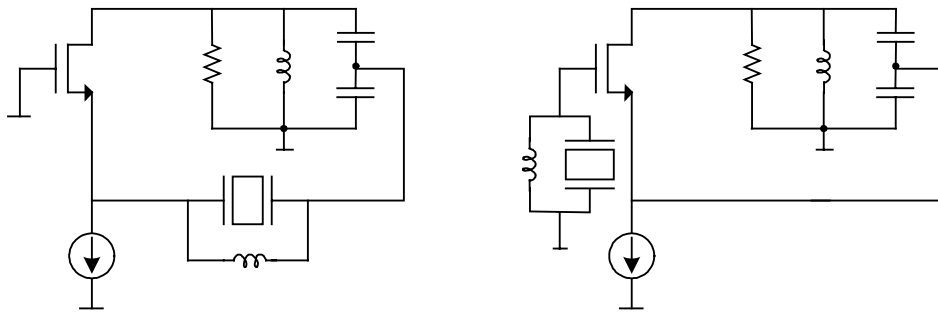
$$\frac{1}{j\omega C_o} = -j\omega_P L_x \left( 1 - \frac{1}{\omega_P^2 L_x C_x} \right)$$

$$\boxed{\omega_P = \omega_S \sqrt{1 + \frac{C_x}{C_o}}}$$

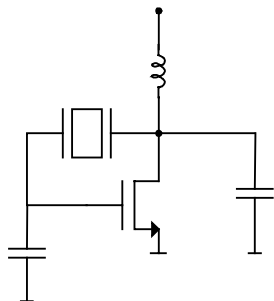
typical values :  $C_x = 0.04 \text{ pF} \rightarrow \omega_P = 1.005 \omega_S$   
 $C_o = 4 \text{ pF}$

### MOS Xtal oscillator

### Colpitts



### Pierce



### Miller

